



#### MMBZ15VDL, MMBZ27VCL

#### **40W PEAK POWER DUAL SURFACE MOUNT TVS**

#### **Features**

- Dual TVS in Common Cathode Configuration for ESD Protection
- 40 Watt Peak Power Dissipation @1.0ms (Unidirectional)
- 225mW Power Dissipation
- Ideally Suited for Automated Insertion
- Low Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3 & 4)

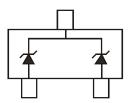
### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Rating Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 Lead Free (§3)
  Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)









Device Schematic

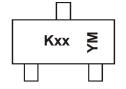
# Ordering Information (Note 5 & 6)

Part Number	Compliance	Case	Packaging
MMBZ15VDL-7-F	Standard	SOT23	3000/Tape & Reel
MMBZ27VCL-7-F	Standard	SOT23	3000/Tape & Reel
MMBZ15VDLQ-7-F	Automotive	SOT23	3000/Tape & Reel
MMBZ27VCLQ-7-F	Automotive	SOT23	3000/Tape & Reel

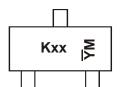
#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.
- 6. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



xx = Product Type Marking Code YM = Date Code Marking for Shanghai Assembly / Test site Y = Year (ex: A = 2013) M = Month (ex: 9 = September)



xx = Product Type Marking Code  $\overline{Y}M$  = Date Code Marking for Chengdu Assembly / Test site  $\overline{Y}$  = Year (ex: A = 2013) M = Month (ex: 9 = September)

#### Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	Т	U	V	W	Х	Υ	Z	Α	В	С	D	Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Power Dissipation (Note 7)	P <sub>PK</sub>	40	W

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 8)	P <sub>D</sub>	225	mW
Thermal Resistance, Junction to Ambient Air (Note 8)	$R_{ hetaJA}$	556	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

V<sub>F</sub> = 0.9V max @ I<sub>F</sub> = 10mA

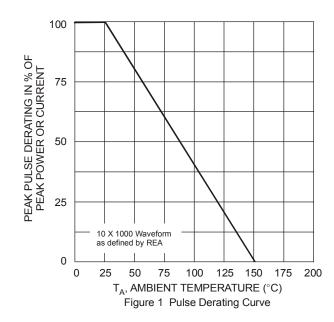
Type	Max Reverse		Reverse	Breakdown Voltage					amping V <sub>c</sub> @ I <sub>PP</sub> te 7)	Typical Temperature
Number	Marking Code	V <sub>RWM</sub>	Leakage I <sub>R</sub> @ V <sub>RWM</sub> (Note 9)	V	/ <sub>BR</sub> (Note 9) (	V)	@ I <sub>T</sub>	Vc	I <sub>PP</sub>	Coefficient
		Volts	nA	Min	Nom	Max	mA	٧	Α	T <sub>C</sub> (%/°C)
MMBZ15VDL	KVJ	12.8	100	14.3	15	15.8	1.0	21.2	1.9	+0.080

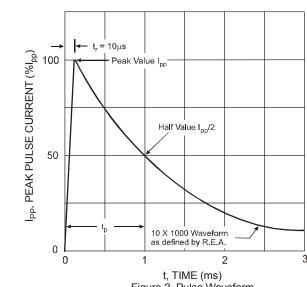
V<sub>F</sub> = 1.1V max @ I<sub>F</sub> = 200mA

	Max Reverse		Reverse	Breakdown Voltage				Max. Clamping Voltage V <sub>c</sub> @ I <sub>PP</sub> (Note 7)		Typical Temperature
Type Number	Marking Code	V <sub>RWM</sub>	Leakage I <sub>R</sub> @ V <sub>RWM</sub> (Note 9)	V	<sub>BR</sub> (Note 9) (	V)	@ I <sub>⊤</sub>	Vc	I <sub>PP</sub>	Coefficient
		Volts	nA	Min	Nom	Max	mA	٧	Α	T <sub>C</sub> (%/°C)
MMBZ27VCL	KVP	22	50	25.65	27	28.35	1.0	38	1.0	+0.090

Notes:

- 7. Non-repetitive current pulse per Figure 2 and derate above  $T_A$  = +25°C per Figure 1.
- 8. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com. 200mW per element must not be exceeded.
- 9. Short duration pulse test used to minimize self-heating effect.







# **DIODES**

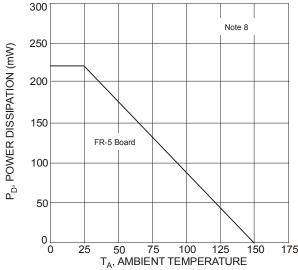
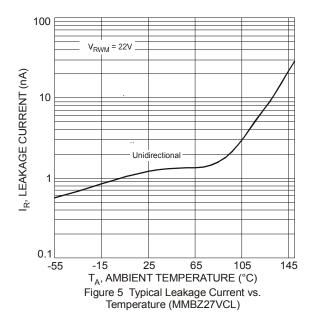


Figure 3 Steady State Power Derating Curve



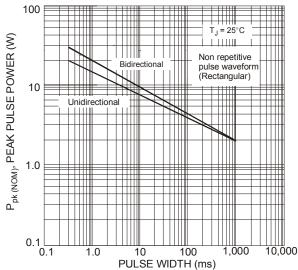


Figure 7 Pulse Rating Curve,  $P_{pk \text{ (NOM)}}$  (W) vs. Pulse Width (ms) Power is defined as  $P_{pk \text{ (NOM)}} = V_{BR \text{(NOM)}} \times I_{pp}$  where  $V_{BR \text{(NOM)}}$  is the nominal breakdown voltage

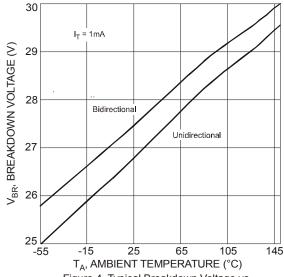


Figure 4 Typical Breakdown Voltage vs. Temperature (MMBZ27VCL)

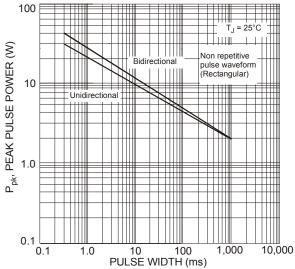
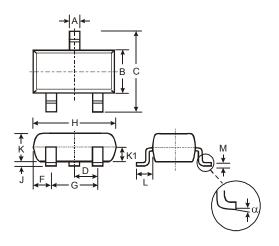


Figure 6 Pulse Rating Curve,  $P_{pk}(W)$  vs. Pulse Width (ms) Power is defined as  $P_{pk} = V_C \times I_{pp}$ 



# **Package Outline Dimensions**

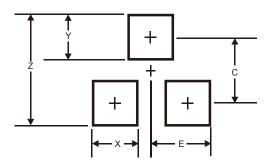
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.903	1.10	1.00					
K1	-	-	0.400					
L	0.45	0.61	0.55					
М	0.085	0.18	0.11					
α	0°	8°	-					
All	Dimens	ions in	mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
F	1.35



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